

Multilayer Power Inductor

CIG21C Series (2012/ EIA 0805)



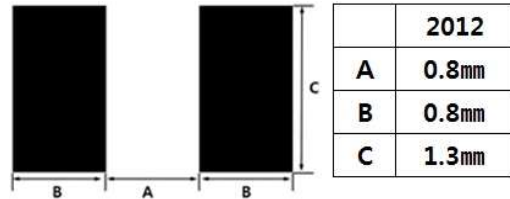
APPLICATION

Mobile phones, DSC, DVC, PDA etc. for DC-DC Converter

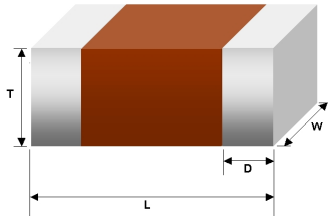
FEATURES

- Suit for small DC-DC converter and choke uses
- Magnetically shielded structure
- Free of all RoHS-regulated substances
- Monolithic structure for high reliability

RECOMMENDED LAND PATTERN



DIMENSION



TYPE	Dimension [mm]			
	L	W	T	D
21	2.0±0.1	1.25±0.1	0.9±0.1	0.5+0.2 -0.3

DESCRIPTION

Part no.	Size (inch/mm)	Inductance (uH)@1MHz	DC Resistance(Ω)	Rated Current (A) Max.
CIG21C2R2MNE	0805/2012	2.2±20%	0.250±20 %	0.80
CIG21C4R7MNE	0805/2012	4.7±20%	0.433±20 %	0.58

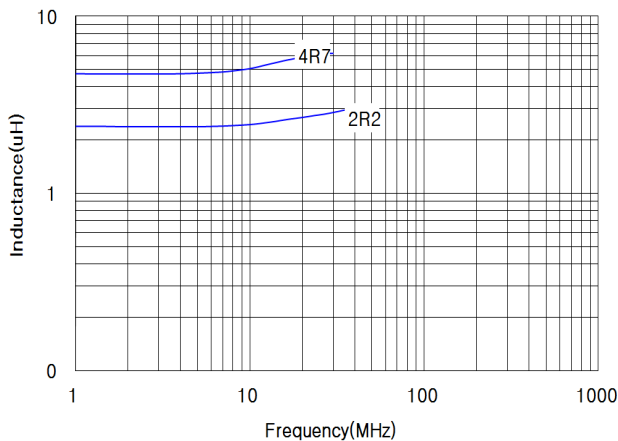
※Rated Current: DC current value when the self-generation of heat rises to 40°C (Reference ambient temperature:25°C)

※Operating temperature range: -40 to +125°C (Including self-temperature rise)

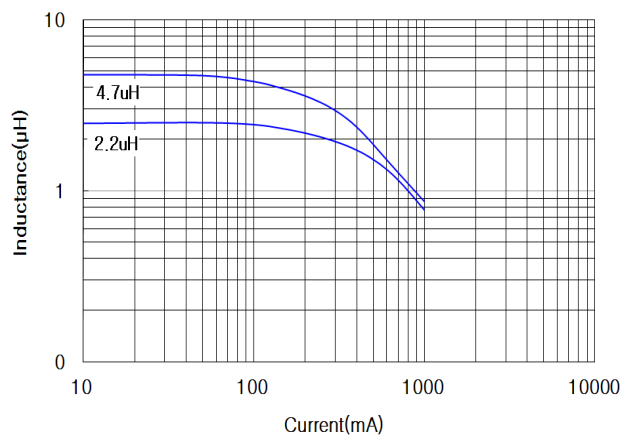
※Test equipment: Agilent :E4991A+16092A

CHARACTERISTIC DATA

1) Frequency characteristics (Typ.)



2) DC Bias characteristics (Typ.)



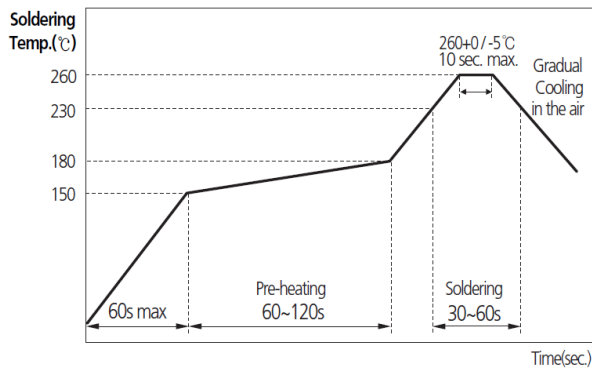
PRODUCT IDENTIFICATION

CI G 21 C 2R2 M N E
(1) (2) (3) (4) (5) (6) (7) (8)

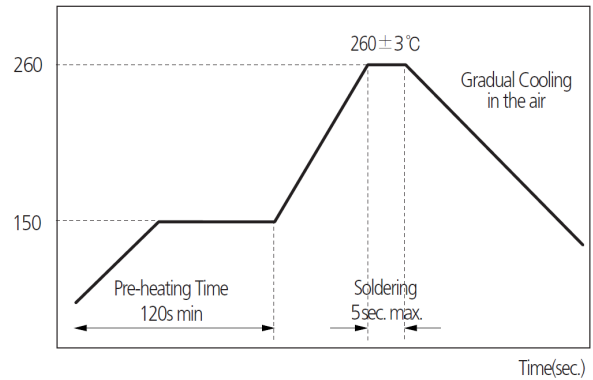
- (1) Chip Inductor
- (2) Power Inductor
- (3) Dimension
- (4) Product Series (C:Choke Type)
- (5) Inductance (2R2:2.2uH)
- (6) Tolerance (M:±20%)
- (7) Thickness option(N:Standard, A:Thinner than standard, B:Thicker than standard)
- (8) Packaging(C:paper tape, E:embossed tape)

RECOMMENDED SOLDERING CONDITION

REFLOW SOLDERING



FLOW SOLDERING



PACKAGING

Packaging Style	Quantity(pcs/reel)
Embossed Taping	3,000

Any data in this sheet are subject to change, modify or discontinue without notice. The data sheets include the typical data for design reference only. If there is any question regarding the data sheets, please contact our sales personnel or application engineers.

单击下面可查看定价，库存，交付和生命周期等信息

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